Notice Inviting Quotation (E-Procurement mode)
कोटेशन को आमंत्रित करने की सूचना (इ-प्रोक्योर्मेंट मोड)

INDIAN INSTITUTE OF TECHNOLOGY DELHI
भारतीय प्रौद्योगिकी संस्थान दिल्ली
HAUZ KHAS, NEW DELHI-110016
हौज ख़ास, नई दिल्ली -110016

Dated/ दिनांक: **07/08/2020**

Open Tender Notice No. / खुला प्रस्ताव निविदा सूचना नंबर: IITD/CRF(SP-3100)/2020

Indian Institute of Technology Delhi is in the process of purchasing following item(s) as per details as given as under.
इंडियन इंस्टीट्यूट ऑफ टेक्नोलॉजी दिल्ली निम्नलिखित मदों की खरीद की प्रक्रिया में है।

Details of the item आइटम का विवरण	**RF Measurement System**
Earnest Money Deposit to be submitted बयाना जमा करने के लिए जमा राशि	**NIL**
Warranty वारंटी अवधि	Comprehensive warranty for 3 years as per the details mentioned in the technical specification table
Performance security निष्पादन सुरक्षा	**10% of FOB value**
Delivery Schedule	**16 weeks from the date of LC opening**

Tender Documents may be downloaded from Central Public Procurement Portal http://eprocure.gov.in/eprocure/app . Aspiring Bidders who have not enrolled / registered in e-procurement should enroll / register before participating through the website http://eprocure.gov.in/eprocure/app . The portal enrolment is free of cost. Bidders are advised to go through instructions provided at 'Instructions for online Bid Submission'.
निविदा दस्तावेज केन्द्रीय सार्वजनिक खरीद पोर्टल http://eprocure.gov.in/eprocure/app से डाउनलोड हो सकते हैं ई-प्रोक्योरमेंट में पंजीकृत नहीं होने वाले इच्छुक बोलीदाताओं को वेबसाइट http://eprocure.gov.in/eprocure/app के माध्यम से भाग लेने से पहले पंजीकरण करना चाहिए। पोर्टल नामांकन मुफ्त है बोलीदाताओं को सलाह दी जाती है कि 'ऑनलाइन बोली के लिए निर्देश' पर दिए गए निर्देशों के माध्यम से जाने की सलाह दी जाए।

Tenderers can access tender documents on the website (For searching in the NIC site, kindly go to Tender Search option and type 'IIT'. Thereafter, Click on "GO" button to view all IIT Delhi tenders). Select the appropriate tender and fill them with all relevant information and submit the completed tender document online on the website http://eprocure.gov.in/eprocure/app as per the schedule given in the next page.
निविदाकर्ता वेबसाइट पर निविदा दस्तावेज का उपयोग कर सकते हैं (एनआईसी साइट में खोज के लिए, कृपया निविदा खोज विकल्प और 'आईआईटी' टाइप करें। उसके बाद, सभी आईआईटी दिल्ली निविदाओं को देखने के लिए "गो" बटन पर क्लिक करें) उपयुक्त निविदा का चयन करें और उन्हें सभी प्रासंगिक सूचनाओं से भरें और वेबसाइट पर http://eprocure.gov.in/eprocure/app पर पूरा निविदा दस्तावेज ऑनलाइन जमा करें। अगले पृष्ठ में दिए गए कार्यक्रम के अनुसार

No manual bids will be accepted. All quotation (both Technical and Financial should be submitted in the E-procurement portal).
कोई मैन्युअल बोली स्वीकार नहीं की जाएगी। सभी कोटेशन (तकनीकी और वित्तीय दोनों को ई-प्रोक्योरमेंट पोर्टल में जमा करना चाहिए)

SCHEDULE

Name of Organization	Indian Institute of Technology Delhi
Tender Type (Open/Limited/EOI/Auction/Single/Global)	Open
Tender Category (Services/Goods/works)	Goods
Type/Form of Contract (Work/Supply/ Auction/ Service/ Buy/ Empanelment/ Sell)	Buy
Product Category (Civil Works/Electrical Works/Fleet Management/ Computer Systems)	Instrument
Source of Fund (Institute/Project)	Budget Code _Nonrecurring/ Project Code PLN01/HF03 and Institute
Is Multi Currency Allowed	Yes
Date of Issue/Publishing	07/08/2020 (15:00 Hrs)
Document Download/Sale Start Date	07/08/2020 (15:00 Hrs)
Document Download/Sale End Date	04/09/2020 (15:00 Hrs)
Last Date and Time for Uploading of Bids	04/09/2020 (15:00 Hrs)
Date and Time of Opening of Technical Bids	07/09/2020 (15:00 Hrs)
Tender Fee	Rs.____NIL_____/- (For Tender Fee) Rs.___NIL_____/- (For EMD) (To be paid through RTGS/NEFT. IIT Delhi Bank details are as under: Name of the Bank A/C : IITD Revenue Account SBI A/C No. : 10773572622 Name of the Bank : State Bank of India, IIT Delhi, Hauz Khas, New Delhi-110016 IFSC Code : SBIN0001077 MICR Code : 110002156 Swift No. : SBININBB547 (This is mandatory that UTR Number is provided in the on-line quotation/bid. (Kindly refer to the UTR Column of the Declaration Sheet at Annexure-II)
EMD	
No. of Covers (1/2/3/4)	02
Bid Validity days (180/120/90/60/30)	90 days (From last date of opening of tender)
Address for Communication	**Prof. Abhisek Dixit** Department of Electrical Engineering Indian Institute of Technology, Hauz Khas, New Delhi – 110016
Contact No.	(+91)-11- 26591156
Email Address	adixit@ee.iitd.ac.in

Chairman Purchase Committee
(Buyer Member)

Instructions for Online Bid Submission/ ऑनलाइन बोली (बिड) के लिए निर्देश:

As per the directives of Department of Expenditure, this tender document has been published on the Central Public Procurement Portal (URL:http://eprocure.gov.in/eprocure/app). The bidders are required to submit soft copies of their bids electronically on the CPP Portal, using valid Digital Signature Certificates. The instructions given below are meant to assist the bidders in registering on the CPP Portal, prepare their bids in accordance with the requirements and submitting their bids online on the CPP Portal.

व्यय विभाग के निर्देशों के अनुसार, यह निविदा दस्तावेज केंद्रीय सार्वजनिक प्रापण पोर्टल (यूआरएल: http: //eprocure.gov.in/eprocure/app) पर प्रकाशित किया गया है। बोलीदाताओं को मान्य डिजिटल हस्ताक्षर प्रमाण पत्र का उपयोग करते हुए सीपीपी पोर्टल पर इलेक्ट्रॉनिक रूप से अपनी बोलियों की सॉफ्ट प्रतियां जमा करना आवश्यक है। सीपीपी पोर्टल पर पंजीकरण करने के लिए निविदाकर्ताओं की सहायता करने के लिए नीचे दिए गए निर्देशों का मतलब है, सीपीपी पोर्टल पर आवश्यकताओं के अनुसार अपनी बोलियां तैयार करें और अपनी बोलियां ऑनलाइन जमा करें।

More information useful for submitting online bids on the CPP Portal may be obtained at:

अधिक जानकारी सीपीपी पोर्टल पर ऑनलाइन बोलियां जमा करने के लिए उपयोगी हो सकती है :
http://eprocure.gov.in/eprocure/app

REGISTRATION

1) Bidders are required to enroll on the e-Procurement module of the Central Public Procurement Portal (URL:http://eprocure.gov.in/eprocure/app) by clicking on the link "Click here to Enroll". Enrolment on the CPP Portal is free of charge.

   बोलीदाताओं को "नामांकन के लिए यहां क्लिक करें" लिंक पर क्लिक करके सेंट्रल पब्लिक प्रोक्युरमेंट पोर्टल (यूआरएल: http: //eprocure.gov.in/eprocure/app) के ई-प्रोक्योरमेंट मॉड्यूल पर भर्ती करना आवश्यक है। सीपीपी पोर्टल पर नामांकन नि: शुल्क है

2) As part of the enrolment process, the bidders will be required to choose a unique username and assign a password for their accounts.

   नामांकन प्रक्रिया के भाग के रूप में, बोलीदाताओं को अपने खाते के लिए एक अद्वितीय उपयोगकर्ता नाम चुनना होगा और एक पासवर्ड प्रदान करना होगा।

3) Bidders are advised to register their valid email address and mobile numbers as part of the registration process. These would be used for any communication from the CPP Portal.

   बोलीदाताओं को सलाह दी जाती है कि पंजीकरण प्रक्रिया के भाग के रूप में अपना वैध ईमेल पता और मोबाइल नंबर पंजीकृत करें। इन का उपयोग सीपीपी पोर्टल से किसी भी संचार के लिए किया जाएगा।

4) Upon enrolment, the bidders will be required to register their valid Digital Signature Certificate (Class II or Class III Certificates with signing key usage) issued by any Certifying Authority recognized by CCA India (e.g. Sify / TCS / nCode / eMudhra etc.), with their profile.

   नामांकन पर, बोलीदाताओं को सीसीए इंडिया द्वारा मान्यता प्राप्त किसी प्रमाणन प्राधिकरण द्वारा जारी किए गए अपने मान्य डिजिटल हस्ताक्षर प्रमाण पत्र (कक्षा द्वितीय या कक्षा III प्रमाण पत्र के साथ महत्वपूर्ण उपयोग पर हस्ताक्षर करने) की आवश्यकता होगी (जैसे सिफी / टीसीएस / एनकोड / ई-मुद्रा आदि) , उनके प्रोफाइल के साथ

5) Only one valid DSC should be registered by a bidder. Please note that the bidders are responsible to ensure that they do not lend their DSCs to others which may lead to misuse.

   केवल एक मान्य डीएससी एक बोलीदाता द्वारा पंजीकृत होना चाहिए। कृपया ध्यान दें कि निविदाकर्ता यह सुनिश्चित करने के लिए ज़िम्मेदार हैं कि वे अपने डीएससी को दूसरों को उधार नहीं देते हैं जिससे दुरुपयोग हो सकता है।

6) Bidder then logs in to the site through the secured log-in by entering their user ID / password and the password of the DSC / eToken.

बोलीदाता फिर अपने यूजर आईडी / पासवर्ड और डीएससी / ईटीकेन के पासवर्ड को दर्ज करके सुरक्षित लॉग-इन के माध्यम से साइट पर लॉग ऑन करता है।

SEARCHING FOR TENDER DOCUMENTS/ निविदा दस्तावेजों के लिए खोजना

1) There are various search options built in the CPP Portal, to facilitate bidders to search active tenders by several parameters. These parameters could include Tender ID, organization name, location, date, value, etc. There is also an option of advanced search for tenders, wherein the bidders may combine a number of search parameters such as organization name, form of contract, location, date, other keywords etc. to search for a tender published on the CPP Portal.

   सीपीपी पोर्टल में निर्मित विभिन्न खोज विकल्प हैं, ताकि बोलीदाताओं को कई मापदंडों से सक्रिय निविदाएं खोज सकें। इन मापदंडों में निविदा आईडी, संगठन का नाम, स्थान, तिथि, मूल्य आदि शामिल हो सकते हैं। निविदाओं के लिए उन्नत खोज का एक विकल्प भी है, जिसमें बोलीदाता कई नामों को जोड़ सकते हैं जैसे संगठन का नाम, अनुबंध का स्थान, स्थान, सीपीपी पोर्टल पर प्रकाशित निविदा की खोज के लिए तारीख, अन्य कीवर्ड आदि।

2) Once the bidders have selected the tenders they are interested in, they may download the required documents / tender schedules. These tenders can be moved to the respective 'My Tenders' folder. This would enable the CPP Portal to intimate the bidders through SMS / e-mail in case there is any corrigendum issued to the tender document.

   बोलीदाताओं ने एक बार निविदाएं चुनी हैं जिसमें वे रुचि रखते हैं, उसका वे आवश्यक दस्तावेज / निविदा कार्यक्रम डाउनलोड कर सकते हैं। ये निविदाएं 'मेरी निविदाओं' फ़ोल्डर में ले जाई जा सकती हैं। इससे सीपीपी पोर्टल को बोलीदाताओं को एसएमएस / ई-मेल के माध्यम से सूचित किया जा सकता है, यदि निविदा दस्तावेज में कोई शुद्धि जारी कि गई है।

3) The bidder should make a note of the unique Tender ID assigned to each tender, in case they want to obtain any clarification / help from the Helpdesk.

   बोलीदाता को प्रत्येक निविदा को निर्दिष्ट अद्वितीय निविदा आईडी का नोट बनाना चाहिए, अगर वे हेल्पडेस्क से कोई स्पष्टीकरण / सहायता प्राप्त करना चाहते हैं।

PREPARATION OF BIDS / बोली (बिड) की तैयारी

1) Bidder should take into account any corrigendum published on the tender document before submitting their bids.

   बोलीदाता को अपनी बोलियां जमा करने से पहले निविदा दस्तावेज पर प्रकाशित किसी भी शुद्धि को ध्यान में रखना चाहिए।

2) Please go through the tender advertisement and the tender document carefully to understand the documents required to be submitted as part of the bid. Please note the number of covers in which the bid documents have to be submitted, the number of documents - including the names and content of each of the document that need to be submitted. Any deviations from these may lead to rejection of the bid.

   कृपया बोली के भाग के रूप में जमा किए जाने वाले दस्तावेजों को समझने के लिए निविदा विज्ञापन और निविदा दस्तावेज ध्यान से देखें। कृपया उन अंकों की संख्या पर ध्यान दें जिन में बोली दस्तावेज जमा करना है, दस्तावेजों की संख्या - जिसमें प्रत्येक दस्तावेज के नाम और सामग्री शामिल हैं, जिन्हें प्रस्तुत करने की आवश्यकता है। इनमें से कोई भी विचलन बोली को अस्वीकार कर सकता है।

3) Bidder, in advance, should get ready the bid documents to be submitted as indicated in the tender document / schedule and generally, they can be in PDF / XLS / RAR / DWF formats. Bid documents may be scanned with 100 dpi with black and white option.

   बोलीदाता, अग्रिम में, निविदा दस्तावेज / अनुसूची में बताए अनुसार प्रस्तुत करने के लिए बोली दस्तावेज तैयार करना चाहिए और आम तौर पर, वे पीडीएफ / एक्सएलएस / आरएआर / डीडब्ल्यूएफ स्वरूपों में हो सकते हैं। बोली दस्तावेजों को 100 डीपीआई के साथ काले और सफेद विकल्प स्कैन किया जा सकता है।

4) To avoid the time and effort required in uploading the same set of standard documents which are required to be submitted as a part of every bid, a provision of uploading such standard documents (e.g. PAN card copy, annual reports, auditor certificates etc.) has been provided to the bidders. Bidders can use "My

Space" area available to them to upload such documents. These documents may be directly submitted from the "My Space" area while submitting a bid, and need not be uploaded again and again. This will lead to a reduction in the time required for bid submission process.

मानक दस्तावेजों के एक ही सेट को अपलोड करने के लिए आवश्यक समय और प्रयास से बचने के लिए जो प्रत्येक बोली के भाग के रूप में जमा करने के लिए आवश्यक हैं, ऐसे मानक दस्तावेज अपलोड करने का प्रावधान (जैसे पैन कार्ड कॉपी, वार्षिक रिपोर्ट, लेखा परीक्षक प्रमाण पत्र आदि)) बोलीदाताओं को प्रदान किया गया है। ऐसे दस्तावेजों को अपलोड करने के लिए बोलीकर्ता उनके लिए उपलब्ध "मेरा स्पेस" क्षेत्र का उपयोग कर सकते हैं। बोली जमा करते समय ये दस्तावेज़ सीधे "मेरा स्पेस" क्षेत्र से जमा किए जा सकते हैं, और उन्हें बार-बार अपलोड करने की ज़रूरत नहीं है इससे बोली जमा प्रक्रिया के लिए आवश्यक समय में कमी आएगी।

SUBMISSION OF BIDS/ बोली (बिड) का जमा करना

1) Bidder should log into the site well in advance for bid submission so that he/she upload the bid in time i.e. on or before the bid submission time. Bidder will be responsible for any delay due to other issues.

   बोलीदाता को बोली प्रस्तुति के लिए अच्छी तरह से साइट पर लॉग इन करना चाहिए ताकि वह समय पर बोली अपलोड कर सके या फिर बोली प्रस्तुत करने के समय से पहले। अन्य मुद्दों के कारण किसी भी देरी के लिए बोलीदाता जिम्मेदार होगा।

2) The bidder has to digitally sign and upload the required bid documents one by one as indicated in the tender document.

   बोलीदाता को निविदा दस्तावेज में दर्शाए अनुसार एक-एक करके आवश्यक बोली दस्तावेजों को डिजिटल हस्ताक्षर और अपलोड करना होगा।

3) Bidder has to select the payment option as "on-line" to pay the tender fee / EMD as applicable and enter details of the instrument. Whenever, EMD / Tender fees is sought, bidders need to pay the tender fee and EMD separately on-line through RTGS (Refer to Schedule, Page No.2).

   बोलीदाता को निविदा शुल्क / ईएमडी को भुगतान के लिए "ऑन लाइन" के रूप में भुगतान विकल्प चुनना होगा और उपकरण का विवरण दर्ज करना होगा। जब भी, ईएमडी / निविदा शुल्क की मांग की जाती है, बोलीदाताओं को टेंडर शुल्क और ईएमडी अलग-अलग आरटीजीएस के माध्यम से ऑन लाइन पर भुगतान करने की आवश्यकता होती है (अनुसूची, पेज नं .2 देखें)।

4) A standard BoQ format has been provided with the tender document to be filled by all the bidders. Bidders are requested to note that they should necessarily submit their financial bids in the format provided and no other format is acceptable. Bidders are required to download the BoQ file, open it and complete the white colored (unprotected) cells with their respective financial quotes and other details (such as name of the bidder). No other cells should be changed. Once the details have been completed, the bidder should save it and submit it online, without changing the filename. If the BoQ file is found to be modified by the bidder, the bid will be rejected.

   एक मानक BoQ प्रारूप को सभी बोलीदाताओं द्वारा भरने के लिए निविदा दस्तावेज प्रदान किया गया है। बोलीदाताओं को इस बात का ध्यान रखना चाहिए कि उन्हें आवश्यक प्रारूप में अपनी वित्तीय बोली जमा करनी चाहिए और कोई अन्य प्रारूप स्वीकार्य नहीं है। बोलीकर्ताओं को BoQ फाइल को डाउनलोड करने, इसे खोलने और अपने संबंधित वित्तीय उद्धरण और अन्य विवरण (जैसे बोलीदाता का नाम) के साथ सफेद रंगीन (असुरक्षित) कोशिकाओं को पूरा करना आवश्यक है। कोई भी अन्य कक्ष नहीं बदला जाना चाहिए। एक बार विवरण पूरा हो जाने पर, बोलीदाता को इसे सहेजना होगा और इसे ऑनलाइन जमा करना होगा, बिना फ़ाइल नाम बदलना। यदि BOQ फ़ाइल को बोलीदाता द्वारा संशोधित किया गया है, तो बोली को खारिज कर दिया जाएगा।

5) The server time (which is displayed on the bidders' dashboard) will be considered as the standard time for referencing the deadlines for submission of the bids by the bidders, opening of bids etc. The bidders should follow this time during bid submission.

   सर्वर का समय (जो बोलीदाताओं के डैशबोर्ड पर प्रदर्शित होता है) बोलीदाताओं द्वारा बोलियों को खोलने के लिए समय सीमा को संदर्भित करने के लिए मानक समय के रूप में माना जाएगा। बोलीदाताओं को खोलना आदि। बोलीदाताओं को बोली प्रस्तुत करने के दौरान इस समय का पालन करना चाहिए।

6) All the documents being submitted by the bidders would be encrypted using PKI encryption techniques to ensure the secrecy of the data. The data entered cannot be viewed by unauthorized persons until the time of bid opening. The confidentiality of the bids is maintained using the secured Socket Layer 128 bit encryption technology. Data storage encryption of sensitive fields is done.

बोलीदाताओं द्वारा प्रस्तुत सभी दस्तावेज पीकेआई एन्क्रिप्शन तकनीकों का उपयोग करके एन्क्रिप्ट किया जाएगा जिससे डेटा की गोपनीयता सुनिश्चित हो सके। दर्ज किए गए डेटा को अनधिकृत व्यक्तियों द्वारा बोली खोलने के समय तक नहीं देखा जा सकता है। बोलियों की गोपनीयता को सुरक्षित सॉकेट लेयर 128 बिट एन्क्रिप्शन तकनीक का उपयोग कर रखा जाता है। संवेदनशील क्षेत्रों का डेटा संग्रहण एन्क्रिप्शन किया जाता है।

7) The uploaded tender documents become readable only after the tender opening by the authorized bid openers.

अपलोड किए गए निविदा दस्तावेज केवल अधिकृत बोलीदाता द्वारा निविदा खोलने के बाद ही पठनीय हो सकते हैं।

8) Upon the successful and timely submission of bids, the portal will give a successful bid submission message & a bid summary will be displayed with the bid no. and the date & time of submission of the bid with all other relevant details.

बोलियों के सफल और समय पर जमा होने पर, पोर्टल एक सफल बोली प्रस्तुत करने का संदेश देगा और एक बोली सारांश बोली संख्या के साथ प्रदर्शित किया जाएगा। और अन्य सभी प्रासंगिक विवरणों के साथ बोली प्रस्तुत करने की तारीख और समय।

9) Kindly add scanned PDF of all relevant documents in a single PDF file of compliance sheet.

कृपया अनुपालन पत्रक की एक पीडीएफ फाइल में सभी प्रासंगिक दस्तावेजों के स्कैन किए गए पीडीएफ़ को जोड़ दें।

ASSISTANCE TO BIDDERS / बोलीदाताओं को सहायता

1) Any queries relating to the tender document and the terms and conditions contained therein should be addressed to the Tender Inviting Authority for a tender or the relevant contact person indicated in the tender.

निविदा दस्तावेज से संबंधित कोई भी प्रश्न और इसमें निहित नियमों और शर्तों को निविदा आमंत्रण प्राधिकरण को निविदा के लिए या निविदा में वर्णित प्रासंगिक संपर्क व्यक्ति से संबोधित किया जाना चाहिए।

2) Any queries relating to the process of online bid submission or queries relating to CPP Portal in general may be directed to the 24x7 CPP Portal Helpdesk. The contact number for the helpdesk is 1800 233 7315.

ऑनलाइन बोली प्रस्तुत करने या सामान्य में सीपीपी पोर्टल से संबंधित प्रश्नों की प्रक्रिया से संबंधित कोई भी प्रश्न 24x7 सीपीपी पोर्टल हैल्पडेस्क पर निर्देशित किया जा सकता है। हेल्पडेस्क के लिए संपर्क संख्या 1800 233 7315 है

General Instructions to the Bidders / बोलीदाताओं के लिए सामान्य निर्देश

1) The tenders will be received online through portal http://eprocure.gov.in/eprocure/app . In the Technical Bids, the bidders are required to upload all the documents in .pdf format.
निविदाएं पोर्टल http://eprocure.gov.in/eprocure/app के माध्यम से ऑनलाइन प्राप्त होंगी तकनीकी बोलियों में, बोलीदाताओं को सभी दस्तावेजों को। पीडीएफ प्रारूप में अपलोड करना होगा।

2) Possession of a Valid Class II/III Digital Signature Certificate (DSC) in the form of smart card/e-token in the company's name is a prerequisite for registration and participating in the bid submission activities through https://eprocure.gov.in/eprocure/app. Digital Signature Certificates can be obtained from the authorized certifying agencies, details of which are available in the web site https://eprocure.gov.in/eprocure/app under the link "Information about DSC".
कंपनी के नाम में स्मार्ट कार्ड / ई-टोकन के रूप में मान्य क्लास II / III डिजिटल हस्ताक्षर प्रमाण पत्र (डीएससी) के पंजीकरण के लिए एक शर्त है और https://eprocure.gov.in/eprocure/ के माध्यम से बोली प्रस्तुत करने की गतिविधियों में भाग ले सकते है। डिजिटल हस्ताक्षर प्रमाण पत्र अधिकृत प्रमाणित एजेंसियों से प्राप्त की जा सकती है, जिनमें से जानकारी "डीएससी के बारे में सूचना" लिंक के तहत वेब साइट https://eprocure.gov.in/eprocure/app पर उपलब्ध है।

3) Tenderer are advised to follow the instructions provided in the 'Instructions to the Tenderer for the e-submission of the bids online through the Central Public Procurement Portal for e Procurement at https://eprocure.gov.in/eprocure/app.
निविदाकर्ता को सलाह दी जाती है कि वे निविदाकार को निर्देश दिए गए हों ताकि ई-प्रोक्योरमेंट के लिए सेंट्रल पब्लिक प्रोकॉर्ममेंट पोर्टल के जरिए https://eprocure.gov.in/eprocure/app पर ऑनलाइन निविदाएं जमा कर सकें।

Central Research Facility
Indian Institute of Technology
Hauz Khas, New Delhi-110 016

NOTICE INVITING QUOTATIONS

Subject: RF Measurement System

Invitation for Tender Offers

Indian Institute of Technology Delhi invites online Bids (Technical bid and Commercial bid) from eligible and experienced OEM (Original Equipment Manufacturer) OR OEM Authorized Dealer for **RF Measurement System** with (warranty period as stated under technical specifications of this tender) on site comprehensive warranty from the date of receipt of the material as per terms & conditions specified in the tender document, which is available on CPP Portal http://eprocure.gov.in/eprocure/app

Brief Tender Specifications for RF Measurement System comprising of RF Probe station, Vector Network Analyzer, Precision dual channel source/measure unit all integrated together such that the setup is self-sustaining and able to provide RF measurements in on-wafer active devices.

TECHNICAL SPECIFICATION

General Technical Requirements (Vendor to provide specific confirmation as part of compliance)

S.No.	Technical Requirements
1.	Equipment being tendered are intended for primary use in a system which will characterize RF response acquired through dedicated probe stations. The integrated RF characterization system will offer a guided wizard customizable for sure connections and correct setup, easy calibration of network analyzer up to probe tip reference plane with automatic self-compensation to remove any placement errors thus yielding repeatable results.
2.	Only vendors with necessary experience and competence to supply, integrate and install such functional system with all its hardware and software components will be selected as eligible bidders.
3.	Vendor to deliver total solution to meet the test needs for the intended research and development. Vendors may be asked to provide necessary evidence to establish their experience & expertise and it is at institute's discretion to accept/reject the same.
4.	System should be unified measurement platform equipped for wafer level, chip or SOC device characterization supplied with all specified accessories, probes, connectors, software, calibration fixtures such that the setup is self-sustaining and able to provide on-wafer active device RF characterization for S-parameters & upgradable in future to test for semiconductor devices such as transistors, amplifiers, filters, other linear / non-linear components to meet intended needs of the institute in integrated and standalone modes.
5.	Wherever called for within the specifications, the offered equipment must be upgradable to higher performance thresholds as defined.
6.	Software supplied should be capable of functioning on the supplied equipment.

7.	The Supplied RF measurement system should be compatible with industry standard load-pull tuner measurement systems. The system should have capability to derive load-dependent device models using the external impedance tuners

A. RF probe station Specifications (Qty:01)

TECHNICAL SPECIFICATION: RF PROBE STATION

Sr. No.	Parameters	Desired Specifications
1	**Wafer Prober**	• Wafer size capability: Shards or wafers 50 mm (2 in.) through 200 mm (8 in.)
		• Motion Control: Manual controls (X-Y direct rotary knobs)
2	**Chuck XY stage**	• Travel: 200mm × 200mm or more
		• Resolution: 5 mm / turn or better
	Chuck Z stage	Travel: Fixed Z mount
	Theta stage	• Travel: ± 5.7° or better
		• Resolution: 0.8° / turn or better
	Chuck	• Non-Thermal High Isolation 200mm chuck
		• Consists of 35 vacuum holes or more
		• 4 vacuum zones (10, 70, 141, 180 mm) or more
		• Integrated with 2 AUX chucks or more
		• AUX chuck (Max size substrate): 15.2 mm x 22.1 mm (0.59 in. x 0.87 in.) ISS substrate or bigger
		• AUX chuck Flatness: ≤ 8 μm or better
3	**Platen**	• Material : Steel for magnetic positioners
		• Lift range : ≥5.5 mm or better
		• Repeatability : ≤ 3.5 μm or better
		• Platen to chuck height : 13 ± 0.8 mm or better

4	**DC Micro-positioners, cables, tips and connectors**	
	Quantity	Four numbers
	Feature resolution	<1 μm or better
	Travel	Travel in X, Y, Z axis : ≥ 12.5 mm or better
	Probe mounts and holders	04 nos. Kelvin probes, fully shielded dual triaxial up to probe tip and 2 nos. needle mount, jack lock includes SSMC (M) connectors
	DC cables and connectors	08 nos. 60cm or better Low Noise triaxial large to Small Connector
	Low leakage DC Kelvin Probe tips	50 tips or more, wedge type, appropriate for contacting metal pads of 30 microns or smaller dimensions
	Base	Magnetic
5	**RF Micro-positioners, cables, tips and connectors**	
	Quantity	Four numbers
	Feature resolution	<1 μm or better
	Travel	Travel in X, Y, Z axis : ≥ 12 mm or better
	Probe mounts and holders	North/South/East/West probe mount
	DC cables and connectors	04 nos. 67 GHz RF cables, V(1.85mm)male/female, flexible, angled style probe body, 36" length for MicroChamber or more
	Base	Magnetic
5a	**Modeling RF probes**	(i) 02 nos. 67GHz, GSG, 50um pitch (ii) 04 nos. 67GHz, GSG, 100um pitch (iii) 02 nos. 67Ghz, GSG, 150um pitch
	RF Probes - Typical Raw Insertion Loss @ approx. 40 GHz	0.7dB or better
	RF Probes - Maximum RF Power @ 2 GHz	37dBm or better
	RF Probes - Typical Contact Resistance on Al	30mΩ or better
	RF Probes - Minimum Pad Size	25x35 μm or smaller
	Max DC current	0.5 A or better
	Max compliance	1 μm or better
5b	**High power RF probes**	02 nos. 65GHz, GSG, 100um pitch
	RF Probes - Max Raw Insertion Loss @ approx. 40 GHz	2dB or better

	RF Probes - Maximum RF Power	> 30W @ 2.4 GHz, > 10W @ 18 GHz, > 7.5W @ 26.5 GHz or better
	RF Probes - Typical Contact Resistance on Al	100mΩ or better
	RF Probes - Minimum Pad Size	80x80 μm or smaller
	Max DC current	5 A or better
	Max compliance	25 μm or better
6	**RF calibration software, calibration substrate, contact substrate and probe polish**	
	Proprietary RF calibration software	Proprietary Standalone GUI based calibration software matched with probe stations and commercial VNAs Calibration Method must support minimum SOLT, Multi-line TRL cal, eLRRM, Hybrid LRRM-SOLR Cal (multiport), 16-Term SVD, LRRM and LRM+ Compatible with live data measurement Automatic calibration feature to measure S-parameters
	RF calibration substrates with probe tip pitch range of GSG probes: (1) 50um – 150um (Qty: 02) (2) 100um - 250um (Qty: 02)	Self-developed On-Wafer RF Calibration Substrate or Impedance Standard Substrates for DC- 110 GHz or better Short, Open 50 Ω Load, Through for GSG Probe
7	**Light shielding**	
	Wafer access	Front access door with rollout stage for easy wafer loading
	Probe compatibility	Standard Micro Chamber top hat compatible to allow access for up to eight probes
	Light attenuation	≥ 120 dB or better
8	**Micro chamber**	
	EMI Shielding	≥ 20 dB 0.5-20 GHz (typical) or better
	Spectral noise floor*	≤ -150 dBVrms/rtHz (≤ 1 MHz) Non thermal or better
	System AC Noise	≤ 15 mVp-p (≤ 1 GHz) Non thermal or better
9	**System electrical performance**	

	Probe leakage	≤ 1 fA or better
	Chuck leakage	≤ 600 fA or better
	Capacitance variation **	≤ 75 fF or better
10	**Microscope and Video Camera**	
	Type	High magnification colour CCD / CMOS digital microscope system
	Field of view	2.62 x 1.97mm (Max), minimum FOV is approximately 1/10 of the maximum FOV shown or better
	Optical paths	2
	Z drive resolution	0.2um or better
	Zoom range	0.5 – 5.0 or wider
	Video frame rates (1024 x 768)	45.5fps or better
11	**Vibration isolation Table**	The prober should have built-in vibration isolation or be equipped with an additional vibration isolation table.
	Vertical and horizontal natural frequency	Typical performance better than 0dB at 6Hz, with -6 dB per octave roll-off to 48Hz and >-18 dB attenuation above 48Hz (with a semi-automatic 8" probe station or equivalent load) or better
	Integrated accessory mount	1 Nos Computer accessory mounting kit for keyboard, mouse, joystick.
	Monitor mount	1 nos Multi-directional LCD monitor support arm
11	**Mandatory accessories**	Any mandatory accessories, such as suitable vacuum pump for wafer stabilization on the chuck must be supplied together with the system.
12	**Warranty**	1 year + 2 years additional
13	**Install base**	Min 50 stations
14	**Standard system**	No customization allowed

B. Vector Network Analyzer Technical Specifications – (Qty: 01)

A vector network analyzer is required for on wafer RF characterization of active devices, such as S-Parameters. Linear as well as non-linear measurements of these devices are within the scope of this measurement setup. Proposed Network Analyzer should be dedicated one box solution / integrated system, with two internal signal sources, internal signal combiner, and a flexible set of switches and RF access points for measurements of the passive and active devices. System must have all the required hardware and software installed in it as per the specifications given below:

Sr. No	Parameters	Specifications
1.	Operating frequency range	50 MHz to 67 GHz or wider
2.	Number of ports	Two
3.	Number of DDS sources	Two
4.	Frequency stability	0.1 ppm/year or better
5.	Frequency accuracy	$\pm 1X10^{-6}$ or better
6.	Frequency resolution	1Hz or better
7.	Power resolution	10mdB or better
8.	IF bandwidth	15MHz or better
9.	Maximum levelled Power with all options installed, Hi Power mode	50 MHz to 2 GHz: -80 dBm to +15 dBm or better 2GHz to 30 GHz :-80 dBm to +10 dBm or better 30GHz to 40 GHz :-80 dBm to +6 dBm or better 40 GHz to 67 GHz :-80 dBm to +10 dBm or better
9b	Power Level Linearity	± 1.5dB or better
9c	Power sweep range	≥ 37 dB : 50MHz to 30GHz or better ≥ 31 dB : 30GHz to 67GHz or better
9d	Test port Input Noise Floor (dBm) @ 10 Hz IFBW, All Ports	≥105 dB : 50MHz to 67GHz or better
10.	Direct Access to source and receivers	Should be available on all ports
11.	Source and Receiver Attenuators	a. Should be available on all ports b. 50 dB source attenuator in 10 dB steps or better c. 50 dB receiver attenuator in 10 dB steps or better
12.	Directivity	≥ 40 dB : 50MHz to 20GHz or better ≥ 38 dB : 20GHz to 50GHz or better ≥ 32 dB : 50GHz to 67GHz or better
13.	Source and Load Match	≥ 36 dB 50MHz to 20GHz or better ≥ 31 dB : 20GHz to 50GHz or better ≥ 24 dB : 50GHz to 67GHz or better
14.	Reflection Tracking	≤ 0.15 dB (over the entire frequency range) or better

15.	Transmission Tracking	≤ 0.25 dB (over the entire frequency range) or better
16.	Phase Tracking	±1.5^{o} (over the entire frequency range) or better
17.	Dynamic Range at test port with all options	≥ 129dB : 500 MHz to 26.5 GHz or better ≥ 110dB :26.5 GHz to 67 GHz or better
18.	Phase Noise @10 KHz offset	≥ 130Bc at 1GHz CW frequency or better ≥ 110dBc : 10GHz CW frequency or better ≥ 106dBc : 20GHz CW frequency or better
19.	Source Harmonics	≤ -50 dBc till 2GHz or better ≤ -60 dBc till 35GHz or better
20.	Internal combiner within VNA	a. Should be available within VNA over the entire frequency range. b. Combined signal output level at test port should be calibrated over the entire frequency range. c. System should have internal switch for making it convenient to change over from/to IMD measurement to/from Normal S-parameter or any other measurement should not require any physical connection/disconnection etc. of DUT with VNA or within VNA. d. Leveled output power at port -1 (meeting harmonics specification) during IMD test should be i) Minimum +5 dBm in 500 MHz to 16GHz frequency band or better Ii) Minimum -1 dBm in 16 to 35 GHz frequency band or better iii) Minimum -5 dBm in 35 GHz to 67 GHz or better e. Variable tone spacing from 100 KHz to 500 MHz should be provided.
21.	Measurement Parameters	s_{11}, s_{12}, s_{21}, s_{22}, a_1,b_1, r_1,r_2, arbitrary ratio
22.	Measurement Features	a. S-parameters of amplifiers b. System should have capability to test all above parameters together without any connections/ disconnections with DUT or within VNA. c. Provides ability to independently set the frequency of internal sources and receivers, and to configure external sources

		d. Swept 2–tone inter-modulation measurements. e. Upgradeable for intermodulation distortion measurements over swept frequency and IMD spectrum at spot frequency.
23.	Test Port Connector	1.85mm(male) bulk head, 50 ohms (nom.)
24.	Calibration	a. System should support source power calibration and suitable USB power sensor 67GHz should be provided b. System should support calibration of multiple channels with IMD, S-parameter and Gain compression in a single calibration session. c. Calibration over entire desired frequency range is needed for following parameter measurements: S-Parameters, Gain Compression, IMD of amplifiers.
25.	Calibration Kit and cables	a. Require electronic calibration kit up to 67GHz: This calibration kit shall have RF connectors (M/F) compatible to DUT end of test port cables. Calibration kit, with which system specifications including measurement accuracies are guaranteed, must be quoted. a. Require compatible flexible VNA test port cables (Qty: 02). Minimum length: 2 feet. Interface for cables: i. Cable -1 DUT end: 1.85 mm (F) ii. Cable -2 DUT end: 1.85 mm (M) iii. Other ends should be compatible with VNA ports. iv. 1.85 mm (m) to 1.85 mm (m) adapter v. 1.85 mm (f) to 1.85 mm (f) adapter
26.	Suitable Torque wrench for VNA test ports and 1.85 mm connectors.	1 no. each
27.	Bias Tee Inputs	Maximum Bias Current ±200 mA or better
		Connectors BNC(f) for ports 1, 2, 3 and 4
		Maximum Bias Voltage ±40 VDC or better
28.	Display	≥ 10 inch color touch screen or better
29.	Operating System	Windows 7 or later
30.	Internal Hard Disk	min. 80 GB internal storage capacity (solid state drive) or better

31.	Capability to save data in ASCII (including S2P)	Feature should be available in the instrument. All files should be compatible to Windows for easy data transportation and documentation.
32.	Interfaces	GPIB, LAN, USB and VGA output.
33.	Printer interface	Standard interface, preferably USB, to be provided.
34.	AC Power Supply	220 to 240 VAC @ 50Hz.
35.	GPIB card	For PCIe interface along with 4m or longer GPIB cable
35.	Warranty	3 years.
36	Bias Network Series ; Qty 2	Frequency range :10 MHz to 67 GHz or wider Connector type: RF input & output 1.85mm (f) , Maximum current 0.5 Amps or better Maximum voltage 40 Volts or better Max. RF power 1 Watts or better
37.	Software & Automation Tool	1. Automation tool for simple, fast and scalable test software development. 2. Automation software should be text based automation with the provision to develop custom plugins for instrument control based on SCPI as well as device-under-test control. 3. Software should provide user interfaces as follows: — Graphical user interface — Command line interface. 4. Automation software should have capability to save test results in at least in the following formats: — Text file — Excel —CSV — STDF — HTML — PDF. 5. Automation software should provide facility for data visualization, test optimization and speed analysis: — Test time Analyzer — Test Results Visualizer. 6. Automation software should support additional tools like plugin manager etc. 7. Automation software should have flexibility to configure automated test systems by remote-control from an external program.

	Option & future upgradeable
38.	a. The Analyzer should be upgradeable to Pulse measurements with three pulse generators and two pulse modulators using external box/ interconnections. b. The Analyzer should be upgradeable to 4 ports, 2 sources and internal combiner without using external box/ interconnections. c. The Analyzer should be upgradeable to low frequency 900Hz d. The Analyzer should be upgradeable to Gain compression measurement with swept frequency. e. System should support upgradeability for group delay and TDR measurements. f. System to be supported with 1 x license software tool for designing linear circuits/passive circuits and its simulation with FEM and MOM techniques. Tool should be able to generate X parameters for nonlinear circuits with multi tone sources. Should provide mature wireless libraries, provide PHY level systems/models that conform to Wireless Connectivity Standards providing "Golden Reference" models to simulate and verify algorithm and system performance early in the design phase.

Terms and Conditions: Compliance to the below points shall be supplied along with the quote. Wherever applicable, technical literature shall be supplied.

1. A single box solution shall be provided for complete specifications of this document.
2. All the specifications offered by vendor shall be guaranteed specifications referenced to instrument's published technical datasheet.
3. If any specification is specified as typical value only, in vendor datasheet then vendor must certify separately that the delivered instrument will comply with the tender specification at the time of installation/commissioning.
4. In case both guaranteed as well as typical specs are given in datasheet, then only guaranteed specs will be considered. Typical specs will be ignored.
5. Vendor must clearly mention the relevant page number/s of datasheets referring to each specification
6. Vendor should indicate the quoted equipment model and accessories parts numbers in support for each specification in tabular form. Vendor to provide point-by-point compliance, consistent with point no. 3, for the above specifications.
7. All parts/accessories should have operating power: 220 to 240 V AC, 50 Hz. All necessary power cords with Indian (3-pin plug) type to be provided by vendor.
8. Temperature range over which all the specification shall be met : 23 ± 3 deg. C
9. Operating temperature range from 0 deg. to 40 deg. C.
10. Warranty: Minimum 3 years warranty is must. If standard warranty is one year, vendor to quote for additional two years warranty separately.

C. Precision Source/Measure Unit, 2 ch, 10 fA, 210 V, 3 A DC/10.5 A Pulse

- **Item** Integrated 4-quadrant source and measurement capabilities
- The 4.3'' color display supports both graphical and numerical view modes
- Free application software to facilitate PC-based instrument control
- High throughput and SCPI command supporting conventional SMU command set

1. Supports two-channel configuration
2. Minimum source resolution: 10 fA/100 nV, minimum measurement resolution: 10 fA/100 nV or better
3. Maximum output: 210 V, 3 A DC/10.5 A pulse or better
4. Arbitrary waveform generation and digitizing capabilities from 10 µs interval or better

D. Tender Specifications for 10 MHz – 67 GHz USB Thermocouple Power Sensor- Qty 1 nos

Parameter	Specification
• Frequency range of 10 MHz to 67 GHz or wider • Fastest measurement speed for thermocouple sensor, > 900 readings/s (free run/fast buffer mode) or better • Best-in-class power linearity of less than 0.8% or better • Wide dynamic range from -35 dBm to +20 dBm or better • Real time measurement uncertainty (MU) feature • S-parameter and gamma correction function	

E. <u>Bid Evaluation / Special Terms for Bidders :</u>

1. Bidders must provide point-by-point compliance to all tendered Technical Specifications, Technical Requirements and Special Terms. Where required, vendor must provide compliance, deviation if any and requisite justification to meet tender requirements in total. Without such details, bids may be summarily rejected at discretion of IIT Delhi.
2. Bids complying with only part requirements of tendered specifications are liable to be rejected. Bidder is accountable for supply, integration, installation and support of all quoted parts including any third party parts not manufactured by them, akin to a turnkey bid. All necessary authorizations must be obtained from third party/part suppliers confirming support to the primary bidder to quote, honor OEM warranty and support during integration, warranty period and for life of the product.
3. Vendors for main test equipment and probe stations must have their own technically equipped application engineer / engineering team to provide installation, training and after sales support.
4. Primary vendor OEM should have well established repair and calibration facility for all supplied main equipment within India.
5. Warranty: Three years on the complete integrated solution.
6. At least 5 similar setup should be found in India.

Vendor Selection /Bid evaluation requirement / criteria

1.	Number of similar units installed in academia / industry worldwide: *>50*
2.	Number of similar units installed within India : *At least 1*
3.	Vendor to attach detailed published technical brochure /data sheet as supporting document. And website link to be provided for the same
4.	**Installation and Commissioning**

	i) Installation, complete interfacing of the system with its subsystems, and commissioning is to be carried out by the vendor's factory-trained engineers, followed by a demonstration of the system's performance to the user's complete satisfaction. ii) An estimated time schedule for installation, commissioning and training must be provided.
5.	**Training** i) The manufacturer/supplier of RF Measurement System should provide at least seven days onsite training initially during installation ii) The supplier or manufacturer should also provide dedicated five days advanced training subsequent to the above training installation. iii) Regular follow up training every six months during the period of extended warranty on mutually convenient dates for hardware, software and application to the laboratory personnel in the installation, operation and maintenance of the instruments.
6.	**Warranty** System should be covered for comprehensive warranty for 3 years from the manufacturer **All parts including spares should be covered under the warranty and this fact should be clearly and explicitly specified in the tender document.** The comprehensive Warranty should cover: 1. All parts including accessories, spares and labour on site 2. Free maintenance and service on site or at factory with no cost, and 3. Regular up-gradation of software
7.	**Power Supply** : Should meet Indian Power standards preferably without use of external converters
8.	**System Consumable Parts**: Basic frequently required spares should be provided for the entire period of extended warranty. A list of these items should be attached with the quotation. The standard scope of supply should include performance verification standards and comprehensive list of consumables for trouble free operation.
9.	**Support and Service:** 1. The manufacturer and/or their Indian representative must have at least two qualified and factory trained service engineer in India to be able to attend to service at IIT Delhi within 48 hours on submitting a complaint. Training certificates from the manufacturer have to be provided with the tender. 2. For warranty period only factory trained and certified engineers are acceptable to attend the service. 3. The response time with an engineer on site must be less than 48 hours from the notification of the failure. The company must provide evidence that it can fulfil this requirement. 4. In case the parts are required to be imported for repairs, the same should be made available within 2 weeks from the date of reporting of the issue. Any extension in this time will need to be compensated by the manufacturer by extending the comprehensive warranty by the excess period taken (i.e. period beyond 2 weeks) in completing the repairs. 5. A 10% performance guarantee will need to be maintained during the period of extended warranty.

A complete set of tender documents* may be Download by prospective bidder free of cost from the website http://eprocure.gov.in/eprocure/app. Bidder has to make payment of requisite fees (i.e. Tender fees (if any) and EMD) online through RTGS/NEFT only.

Terms & Conditions Details

Sl. No.	Specification
1.	**Due date**: The tender has to be submitted on-line before the due date. The offers received after the due date and time will not be considered. No manual bids will be considered.
2.	**Preparation of Bids**: The offer/bid should be submitted in two bid systems (i.e.) Technical bid and financial bid. The technical bid should consist of all technical details along with commercial terms and conditions. Financial bid should indicate item wise price for the items mentioned in the technical bid in the given format i.e BoQ_XXXX. The Technical bid and the financial bid should be submitted Online. ***Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as 'Optional' in the specs is not to be included for overall comparison.***
3.	**EMD (if applicable)**: The tenderer should submit an EMD amount through RTGS/NEFT. The Technical Bid without EMD would be considered as UNRESPONSIVE and will not be accepted. The EMD will be refunded without any interest to the unsuccessful bidders after the award of contract. Refer to Schedule (at page 1 of this document) for its actual place of submission.
4.	**Refund of EMD**: The EMD will be returned to unsuccessful Tenderer only after the Tenders are finalized. In case of successful Tenderer, it will be retained till the successful and complete installation of the equipment.
5.	**Opening of the tender**: The online bid will be opened by a committee duly constituted for this purpose. Online bids (complete in all respect) received along with EMD (if any) will be opened as mentioned at "Annexure: Schedule" in presence of bidders representative if available. Only one representative will be allowed to participate in the tender opening. Bid received without EMD (if present) will be rejected straight way. The technical bid will be opened online first and it will be examined by a technical committee (as per specification and requirement). The financial offer/bid will be opened only for the offer/bid which technically meets all requirements as per the specification, and will be opened in the presence of the vendor's representatives subsequently for further evaluation. The bidders if interested may participate on the tender opening Date and Time. The bidder should produce authorization letter from their company to participate in the tender opening.
6.	**Acceptance/ Rejection of bids:** The Committee reserves the right to reject any or all offers without assigning any reason.
7.	**Pre-qualification criteria:** (i) Bidders should be the manufacturer / authorized dealer. Letter of Authorization from original equipment manufacturer (OEM) on the same and specific to the tender should be enclosed. (ii) An undertaking from the OEM is required stating that they would facilitate the bidder on a regular basis with technology/product updates and extend support for the warranty as well. (Ref. Annexure-II) (iii) OEM should be internationally reputed Branded Company. (iv) Non-compliance of tender terms, non-submission of required documents, lack of clarity of the specifications, contradiction between bidder specification and supporting documents etc. may lead to rejection of the bid. (v) In the tender, either the Indian agent on behalf of the Principal/OEM or Principal/OEM itself can bid but both cannot bid simultaneously for the same item/product in the same tender. (vi) If an agent submits bid on behalf of the Principal/OEM, the same agent shall not submit a bid on behalf of another Principal/OEM in the same tender for the same item/product.
8.	**Performance Security**: The supplier shall require to submit the performance security in the form of irrevocable bank guarantee issued by any Indian Nationalized Bank for an amount which is stated at page #1 of the tender document within 21 days from the date of receipt of the purchase order/LC and should be kept valid for a period of 60 days beyond the date of completion of warranty period.

9.	**Force Majeure:** The Supplier shall not be liable for forfeiture of its performance security, liquidated damages or termination for default, if and to the extent that, it's delay in performance or other failure to perform its obligations under the Contract is the result of an event of Force Majeure. • For purposes of this Clause, "Force Majeure" means an event beyond the control of the Supplier and not involving the Supplier's fault or negligence and not foreseeable. Such events may include, but are not limited to, acts of the Purchaser either in its sovereign or contractual capacity, wars or revolutions, fires, floods, epidemics, quarantine restrictions and freight embargoes. • If a Force Majeure situation arises, the Supplier shall promptly notify the Purchaser in writing of such conditions and the cause thereof. Unless otherwise directed by the Purchaser in writing, the Supplier shall continue to perform its obligations under the Contract as far as is reasonably practical, and shall seek all reasonable alternative means for performance not prevented by the Force Majeure event.
10.	**Risk Purchase Clause**: In event of failure of supply of the item/equipment within the stipulated delivery schedule, the purchaser has all the right to purchase the item/equipment from the other source on the total risk of the supplier under risk purchase clause.
11.	**Packing Instructions**: Each package will be marked on three sides with proper paint/indelible ink, the following: i. Item Nomenclature ii. Order/Contract No. iii. Country of Origin of Goods iv. Supplier's Name and Address v. Consignee details vi. Packing list reference number
12.	**Delivery and Documents:** Delivery of the goods should be made within a maximum of 16 weeks *(for goods ready for shipment)* & Maximum *(To be filled by Purchaser)* weeks *(For special/ to be fabricated goods) from the date of the opening of LC*. Within 24 hours of shipment, the supplier shall notify the purchaser and the insurance company by cable/telex/fax/e mail the full details of the shipment including contract number, railway receipt number/ AAP etc. and date, description of goods, quantity, name of the consignee, invoice etc. The supplier shall mail the following documents to the purchaser with a copy to the insurance company: 1. 4 Copies of the Supplier invoice showing contract number, goods' description, quantity 2. unit price, total amount; 3. Insurance Certificate if applicable; 4. Manufacturer's/Supplier's warranty certificate; 5. Inspection Certificate issued by the nominated inspection agency, if any 6. Supplier's factory inspection report; and 7. Certificate of Origin (if possible by the beneficiary); 8. Two copies of the packing list identifying the contents of each package. 9. The above documents should be received by the Purchaser before arrival of the Goods (except where the Goods have been delivered directly to the Consignee with all documents) and, if not received, the Supplier will be responsible for any consequent expenses.
13.	**Delayed delivery:** If the delivery is not made within the due date for any reason, the Committee will have the right to impose penalty 1% per week and the maximum deduction is 10% of the contract value / price.
14.	**Prices**: The price should be quoted in net per unit (after breakup) and must include all packing and delivery charges. The offer/bid should be exclusive of taxes and duties, which will be paid by the purchaser as applicable. However the percentage of taxes & duties shall be clearly indicated.

	The price should be quoted without custom duty and excise duty, since IIT Delhi is exempted from payment of Excise Duty and is eligible for concessional rate of custom duty. Necessary certificate will be issued on demand. **In case of imports, the price should be quoted on FOB/FCA origin Airport Basis only.** Under special circumstances (eg. perishable chemicals), when the item is imported on CIF/CIP, please indicate CIF/CIP charges separately upto IIT Delhi indicating the mode of shipment. IIT Delhi will make necessary arrangements for the clearance of imported goods at the Airport/Seaport. Hence the price should not include the above charges. **At any circumstances, it is the responsibility of the foreign supplier to handover the material to our forwarder at the origin airport after completing all the inland clearing. No Ex- Works consignment will be entertained.** "In case of **CIF/CIP** shipments, kindly provide the shipment information at least 2 days in advance before landing the shipment along with the documents i.e. invoice, packing list, forwarder Name, address, contact No. in India to save penalty/demurrage charges (imposed by Indian Customs) . Otherwise these charges will be recovered from the supplier/Indian Agent." ***Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as 'Optional' in the specs is not to be included for overall comparison.***
15.	**Notices:** For the purpose of all notices, the following shall be the address of the Purchaser and Supplier. **Purchaser: Dr. Abhisek Dixit** Department of Electrical Engineering Indian Institute of Technology Hauz Khas, New Delhi - 110016. **Supplier:** (To be filled in by the supplier) **(All supplier's should submit its supplies information as per Annexure-II).** _____ _____
16.	**Progress of Supply**: Wherever applicable, supplier shall regularly intimate progress of supply, in writing, to the Purchaser as under: 1. Quantity offered for inspection and date; 2. Quantity accepted/rejected by inspecting agency and date; 3. Quantity dispatched/delivered to consignees and date; 4. Quantity where incidental services have been satisfactorily completed with date; 5. Quantity where rectification/repair/replacement effected/completed on receipt of any communication from consignee/Purchaser with date; 6. Date of completion of entire Contract including incidental services, if any; and **7.** Date of receipt of entire payments under the Contract (In case of stage-wise inspection, details required may also be specified).
17.	**Inspection and Tests:** Inspection and tests prior to shipment of Goods and at final acceptance are as follows: • After the goods are manufactured and assembled, inspection and testing of the goods shall be carried out at the supplier's plant by the supplier, prior to shipment to check whether the goods are in conformity with the technical specifications attached to the purchase order. Manufacturer's test certificate with data sheet shall be issued to this effect and submitted along with the delivery documents. The purchaser shall be present at the supplier's premises during such inspection and testing if need is felt. The location where the inspection is required to be conducted should be clearly indicated. The supplier shall inform the purchaser about the site preparation, if any, needed for installation of the goods at the purchaser's site at the time of submission of order acceptance. • The acceptance test will be conducted by the Purchaser, their consultant or other such person nominated by the Purchaser at its option after the equipment is installed at purchaser's site in the

	presence of supplier's representatives. The acceptance will involve trouble free operation and ascertaining conformity with the ordered specifications and quality. There shall not be any additional charges for carrying out acceptance test. No malfunction, partial or complete failure of any part of the equipment is expected to occur. The Supplier shall maintain necessary log in respect of the result of the test to establish to the entire satisfaction of the Purchaser, the successful completion of the test specified. • In the event of the ordered item failing to pass the acceptance test, a period not exceeding one weeks will be given to rectify the defects and clear the acceptance test, failing which the Purchaser reserve the right to get the equipment replaced by the Supplier at no extra cost to the Purchaser. • Successful conduct and conclusion of the acceptance test for the installed goods and equipment shall also be the responsibility and at the cost of the Supplier.
18.	**Resolution of Disputes**: The dispute resolution mechanism to be applied pursuant shall be as follows: • In case of Dispute or difference arising between the Purchaser and a domestic supplier relating to any matter arising out of or connected with this agreement, such disputes or difference shall be settled in accordance with the Indian Arbitration & Conciliation Act, 1996, the rules there under and any statutory modifications or re-enactments thereof shall apply to the arbitration proceedings. The dispute shall be referred to the Director, Indian Institute of Technology (IIT) Delhi and if he is unable or unwilling to act, to the sole arbitration of some other person appointed by him willing to act as such Arbitrator. The award of the arbitrator so appointed shall be final, conclusive and binding on all parties to this order. • In the case of a dispute between the purchaser and a Foreign Supplier, the dispute shall be settled by arbitration in accordance with provision of sub-clause (a) above. But if this is not acceptable to the supplier then the dispute shall be settled in accordance with provisions of UNCITRAL (United Nations Commission on International Trade Law) Arbitration Rules. • The venue of the arbitration shall be the place from where the order is issued.
19.	**Applicable Law:** The place of jurisdiction would be New Delhi (Delhi) INDIA.
20.	**Right to Use Defective Goods** If after delivery, acceptance and installation and within the guarantee and warranty period, the operation or use of the goods proves to be unsatisfactory, the Purchaser shall have the right to continue to operate or use such goods until rectifications of defects, errors or omissions by repair or by partial or complete replacement is made without interfering with the Purchaser's operation.
21.	**Supplier Integrity** The Supplier is responsible for and obliged to conduct all contracted activities in accordance with the Contract using state of the art methods and economic principles and exercising all means available to achieve the performance specified in the contract.
22.	**Training** The Supplier is required to provide training to the designated Purchaser's technical and end user personnel to enable them to effectively operate the total equipment.
23.	**Installation & Demonstration** The supplier is required to done the installation and demonstration of the equipment within one month of the arrival of materials at the IITD site of installation, otherwise the penalty clause will be the same as per the supply of materials. In case of any mishappening/damage to equipment and supplies during the carriage of supplies from the origin of equipment to the installation site, the supplier has to replace it with new equipment/supplies immediately at his own risk. Supplier will settle his claim with the insurance company as per his convenience. IITD will not be liable to any type of losses in any form.
24.	**Insurance:** For delivery of goods at the purchaser's premises, the insurance shall be obtained by the supplier in an amount equal to 110% of the value of the goods from "warehouse to warehouse" (final destinations) on "All Risks" basis including War Risks and Strikes. The insurance shall be valid for a

	period of not less than 3 months after installation and commissioning. **In case of orders placed on FOB/FCA basis, the purchaser shall arrange Insurance. If orders placed on CIF/CIP basis, the insurance should be up to IIT Delhi.**
25.	**Incidental services:** The incidental services also include: • Furnishing of 01 set of detailed operations & maintenance manual. • Arranging the shifting/moving of the item to their location of final installation within IITD premises at the cost of Supplier through their Indian representatives.
26.	**Warranty**: (i) Warranty period shall be (as stated at page #2 of this tender) from date of installation of Goods at the IITD site of installation. The Supplier shall, in addition, comply with the performance and/or consumption guarantees specified under the contract. If for reasons attributable to the Supplier, these guarantees are not attained in whole or in part, the Supplier shall at its discretion make such changes, modifications, and/or additions to the Goods or any part thereof as may be necessary in order to attain the contractual guarantees specified in the Contract at its own cost and expense and to carry out further performance tests. The warranty should be comprehensive on site. (ii) The Purchaser shall promptly notify the Supplier in writing of any claims arising under this warranty. Upon receipt of such notice, the Supplier shall immediately within in 02 days arrange to repair or replace the defective goods or parts thereof free of cost at the ultimate destination. The Supplier shall take over the replaced parts/goods at the time of their replacement. No claim whatsoever shall lie on the Purchaser for the replaced parts/goods thereafter. The period for correction of defects in the warranty period is 02 days. If the supplier having been notified fails to remedy the defects within 02 days, the purchaser may proceed to take such remedial action as may be necessary, at the supplier's risk and expenses and without prejudice to any other rights, which the purchaser may have against the supplier under the contract. (iii) The warranty period should be clearly mentioned. The maintenance charges (AMC) under different schemes after the expiry of the warranty should also be mentioned. The comprehensive warranty will commence from the date of the satisfactory installation/commissioning of the equipment against the defect of any manufacturing, workmanship and poor quality of the components. (iv) After the warranty period is over, Annual Maintenance Contract (AMC)/Comprehensive Maintenance Contract (CMC) up to next two years should be started. The AMC/CMC charges will not be included in computing the total cost of the equipment.
27.	**Governing Language** The contract shall be written in English language. English language version of the Contract shall govern its interpretation. All correspondence and other documents pertaining to the Contract, which are exchanged by the parties, shall be written in the same language.
28.	**Applicable Law** The Contract shall be interpreted in accordance with the laws of the Union of India and all disputes shall be subject to place of jurisdiction.
29.	**Notices** • Any notice given by one party to the other pursuant to this contract/order shall be sent to the other party in writing or by cable, telex, FAX or e mail and confirmed in writing to the other party's address. • A notice shall be effective when delivered or on the notice's effective date, whichever is later.
30.	**Taxes** Suppliers shall be entirely responsible for all taxes, duties, license fees, octroi, road permits, etc., incurred until delivery of the contracted Goods to the Purchaser. However, GST etc, in respect of the transaction between the Purchaser and the Supplier shall be payable extra, if so stipulated in the order.

	For research purpose(s) **ONLY**, 5% GST will be applicable with concessional GST Certificate.
31.	**Duties** IIT Delhi is exempted from paying custom duty under notification No.51/96 (partially or full) and necessary "Custom Duty Exemption Certificate" can be issued after providing following information and Custom Duty Exemption Certificate will be issued to the shipment in the name of the Institute, (no certificate will be issued to third party): The procured product should be used for teaching, scientific and research work only. a) Shipping details i.e. Master Airway Bill No. and House Airway No. (if exists) b) Forwarder details i.e. Name, Contact No., etc. IIT Delhi is partially exempted from paying GST and necessary GST Exemption Certificate will be provided for which following information are required. b) Quotation with details of Basic Price, Rate, Tax & Amount on which ED is applicable c) Supply Order Copy d) Proforma-Invoice Copy.
32.	**Agency Commission**: Agency commission if any will be paid to the Indian agent in Rupees on receipt of the equipment and after satisfactory installation. Agency Commission will not be paid in foreign currency under any circumstances. The details should be explicitly shown in Tender even in case of Nil commission. The tenderer should indicate the percentage of agency commission to be paid to the Indian agent.
33.	**Payment**: (i) For imported items Payment will be made through irrevocable Letter of Credit (LC) Cash Against Documents (CAD)/Against delivery/after satisfactory installation by T.T. Letter of Credit (LC) will be established in favour of foreign Supplier after the submission of performance security. The letter of credit (LC) will be established on the exchange rates as applicable on the date of establishment. For Imports, LC will be opened for 100% FOB/CIF value. 80% of the LC amount shall be released on presentation of complete and clear shipping documents and 20% of the LC amount shall be released after the installation and demonstration of the equipment at the INST site of installation in faultless working condition for period of 60 days from the date of the satisfactory installation and subject to the production of unconditional performance bank guarantee as specified in Clause 8 of tender terms and conditions. (ii) For Indigenous supplies, 100% payment shall be made by the Purchaser against delivery, inspection, successful installation, commissioning and acceptance of the equipment at IITD in good condition and to the entire satisfaction of the Purchaser and on production of unconditional performance bank guarantee as specified in Clause 9 of tender terms and conditions. (iii) Indian Agency commission (IAC), if any shall be paid after satisfactory installation & commissioning of the goods at the destination at the exchange rate prevailing on the date of negotiation of LC documents, subject to DGS&D registration for restricted items. (iv) All the bank charges within India will be borne by the Institute and outside India will be borne by the Supplier.
34.	**User list:** Brochure detailing technical specifications and performance, list of industrial and educational establishments where the items enquired have been supplied must be provided. (Ref. Annexure-III)
35.	**Manuals and Drawings** (i) Before the goods and equipment are taken over by the Purchaser, the Supplier shall supply operation and maintenance manuals. These shall be in such details as will enable the Purchaser to operate, maintain, adjust and repair all parts of the works as stated in the specifications. (ii) The Manuals shall be in the ruling language (English) in such form and numbers as stated in the contract.

	(iii) Unless and otherwise agreed, the goods equipment shall not be considered to be completed for the purposes of taking over until such manuals and drawing have been supplied to the Purchaser.
36.	**Application Specialist**: The Tenderer should mention in the Techno-Commercial bid the availability and names of Application Specialist and Service Engineers in the nearest regional office. (Ref. to Annexure-III)
37.	**Site Preparation**: The supplier shall inform to the Institute about the site preparation, if any, needed for the installation of equipment, immediately after the receipt of the purchase order. The supplier must provide complete details regarding space and all the other infrastructural requirements needed for the equipment, which the Institute should arrange before the arrival of the equipment to ensure its timely installation and smooth operation thereafter. The supplier shall visit the Institute and see the site where the equipment is to be installed and may offer his advice and render assistance to the Institute in the preparation of the site and other pre-installation requirements.
38.	**Spare Parts** The Supplier may be required to provide any or all of the following materials, notifications, and information pertaining to spare parts manufactured or distributed by the Supplier: ii. Such spare parts as the Purchaser may elect to purchase from the Supplier, providing that this election shall not relieve the Supplier of any warranty obligations under the Contract; and iii. In the event of termination of production of the spare parts: iv. Advance notification to the Purchaser of the pending termination, in sufficient time to permit the Purchaser to procure needed requirements; and v. Following such termination, furnishing at no cost to the Purchaser, the blueprints, drawings and specifications of the spare parts, if requested. Supplier shall carry sufficient inventories to assure ex-stock supply of consumable spares for the Goods, such as gaskets, plugs, washers, belts etc. Other spare parts and components shall be supplied as promptly as possible but in any case within six months of placement of order.
39.	**Defective Equipment**: If any of the equipment supplied by the Tenderer is found to be substandard, refurbished, un-merchantable or not in accordance with the description/specification or otherwise faulty, the committee will have the right to reject the equipment or its part. The prices of such equipment shall be refunded by the Tenderer with 18% interest if such payments for such equipment have already been made. All damaged or unapproved goods shall be returned at suppliers cost and risk and the incidental expenses incurred thereon shall be recovered from the supplier. Defective part in equipment, if found before installation and/or during warranty period, shall be replaced within 45 days on receipt of the intimation from this office at the cost and risk of supplier including all other charges. In case supplier fails to replace above item as per above terms & conditions, IIT Delhi may consider "Banning" the supplier.
40.	**Termination for Default** The Purchaser may, without prejudice to any other remedy for breach of contract, by written notice of default sent to the Supplier, terminate the Contract in whole or part: i. If the Supplier fails to deliver any or all of the Goods within the period(s) specified in the order, or within any extension thereof granted by the Purchaser; or ii If the Supplier fails to perform any other obligation(s) under the Contract. iii If the Supplier, in the judgment of the Purchaser has engaged in corrupt or fraudulent practices in competing for or in executing the Contract. ● For the purpose of this Clause: i. "**Corrupt practice**" means the offering, giving, receiving or soliciting of anything of value to influence the action of a public official in the procurement process or in contract execution. ii. "**Fraudulent practice**" means a misrepresentation of facts in order to influence a procurement process or the execution of a contract to the detriment of the Borrower, and includes

	collusive practice among Bidders (prior to or after bid submission) designed to establish bid prices at artificial non-competitive levels and to deprive the Borrower of the benefits of free and open competition;'" • In the event the Purchaser terminates the Contract in whole or in part, the Purchaser may procure, upon such terms and in such manner, as it deems appropriate, Goods or Services similar to those undelivered, and the Supplier shall be liable to the Purchaser for any excess costs for such similar Goods or Services. However, the Supplier shall continue the performance of the Contract to the extent not terminated.
41.	**Shifting**: After 1-2 years once our new Academic Block will be ready, the supplier has to shift and reinstall the instrument free of cost (if required).
42.	**Downtime:** During the warranty period not more than 5% downtime will be permissible. For every day exceeding permissible downtime, penalty of 1/365 of the 5% FOB value will be imposed. Downtime will be counted from the date and time of the filing of complaint with in the business hours.
43.	**Training of Personnel:** The supplier shall be required to undertake to provide the technical training to the personnel involved in the use of the equipment at the Institute premises, immediately after completing the installation of the equipment for a minimum period of one week at the supplier's cost.
44.	**Disputes and Jurisdiction**: Any legal disputes arising out of any breach of contract pertaining to this tender shall be settled in the court of competent jurisdiction located within New Delhi.
45.	**Compliancy certificate**: This certificate must be provided indicating conformity to the technical specifications. (Annexure-I)

ANNEXURE-I

COMPLIANCE SHEET

TECHNICAL SPECIFICATION

TECHNICAL SPECIFICATION

S.No.	Technical Requirements	Compliance (Yes/No)
1.	Equipment being tendered are intended for primary use in a system which will characterize RF response acquired through dedicated probe stations. The integrated RF characterization system will offer a guided wizard customizable for sure connections and correct setup, easy calibration of network analyzer up to probe tip reference plane with automatic self-compensation to remove any placement errors thus yielding repeatable results.	
2.	Only vendors with necessary experience and competence to supply, integrate and install such functional system with all its hardware and software components will be selected as eligible bidders.	
3.	Vendor to deliver total solution to meet the test needs for the intended research and development. Vendors may be asked to provide necessary evidence to establish their experience & expertise and it is at institute's discretion to accept/reject the same.	
4.	System should be unified measurement platform equipped for wafer level, chip or SOC device characterization supplied with all specified accessories, probes, connectors, software, calibration fixtures such that the setup is self-sustaining and able to provide on-wafer active device RF characterization for S-parameters & upgradable in future to test for semiconductor devices such as transistors, amplifiers, filters, other linear / non-linear components to meet intended needs of the institute in integrated and standalone modes.	
5.	Wherever called for within the specifications, the offered equipment must be upgradable to higher performance thresholds as defined.	

6.	Software supplied should be capable of functioning on the supplied equipment.	
7.	The Supplied RF measurement system should be compatible with industry standard load-pull tuner measurement systems. The system should have capability to derive load-dependent device models using the external impedance tuners	

C. RF probe station Specifications (Qty:01)

TECHNICAL SPECIFICATION: RF PROBE STATION

Sr. No.	Parameters	Desired Specifications	Compliance (Yes/No)
1	**Wafer Prober**	• Wafer size capability: Shards or wafers 50 mm (2 in.) through 200 mm (8 in.)	
		• Motion Control: Manual controls (X-Y direct rotary knobs)	
2	**Chuck XY stage**	• Travel: 200mm × 200mm or more	
		• Resolution: 5 mm / turn or better	
	Chuck Z stage	Travel: Fixed Z mount	
	Theta stage	• Travel: ± 5.7° or better	
		• Resolution: 0.8° / turn or better	
	Chuck	• Non-Thermal High Isolation 200mm chuck	
		• Consists of 35 vacuum holes or more	
		• 4 vacuum zones (10, 70, 141, 180 mm) or more	
		• Integrated with 2 AUX chucks or more	
		• AUX chuck (Max size substrate): 15.2 mm x 22.1 mm (0.59 in. x 0.87 in.) ISS substrate or bigger	
		• AUX chuck Flatness: ≤ 8 µm or better	

3	**Platen**	• Material : Steel for magnetic positioners	
		• Lift range : ≥5.5 mm or better	
		• Repeatability : ≤ 3.5 μm or better	
		• Platen to chuck height : 13 ± 0.8 mm or better	
4	**DC Micro-positioners, cables, tips and connectors**		
	Quantity	Four numbers	
	Feature resolution	<1 μm or better	
	Travel	Travel in X, Y, Z axis : ≥ 12.5 mm or better	
	Probe mounts and holders	04 nos. Kelvin probes, fully shielded dual triaxial up to probe tip and 2 nos. needle mount, jack lock includes SSMC (M) connectors	
	DC cables and connectors	08 nos. 60cm or better Low Noise triaxial large to Small Connector	
	Low leakage DC Kelvin Probe tips	50 tips or more, wedge type, appropriate for contacting metal pads of 30 microns or smaller dimensions	
	Base	Magnetic	
5	**RF Micro-positioners, cables, tips and connectors**		
	Quantity	Four numbers	
	Feature resolution	<1 μm or better	
	Travel	Travel in X, Y, Z axis : ≥ 12 mm or better	
	Probe mounts and holders	North/South/East/West probe mount	
	DC cables and connectors	04 nos. 67 GHz RF cables, V(1.85mm)male/female, flexible, angled style probe body, 36" length for MicroChamber or more	
	Base	Magnetic	
5a	**Modeling RF probes**	(iv) 02 nos. 67GHz, GSG, 50um pitch (v) 04 nos. 67GHz, GSG, 100um pitch	

		(vi) 02 nos. 67Ghz, GSG, 150um pitch	
	RF Probes - Typical Raw Insertion Loss @ approx. 40 GHz	0.7dB or better	
	RF Probes - Maximum RF Power @ 2 GHz	37dBm or better	
	RF Probes - Typical Contact Resistance on Al	30mΩ or better	
	RF Probes - Minimum Pad Size	25x35 μm or smaller	
	Max DC current	0.5 A or better	
	Max compliance	1 μm or better	
5b	**High power RF probes**	02 nos. 65GHz, GSG, 100um pitch	
	RF Probes - Max Raw Insertion Loss @ approx. 40 GHz	2dB or better	
	RF Probes - Maximum RF Power	> 30W @ 2.4 GHz, > 10W @ 18 GHz, > 7.5W @ 26.5 GHz or better	
	RF Probes - Typical Contact Resistance on Al	100mΩ or better	
	RF Probes - Minimum Pad Size	80x80 μm or smaller	
	Max DC current	5 A or better	
	Max compliance	25 μm or better	
6	**RF calibration software, calibration substrate, contact substrate and probe polish**		
	Proprietary RF calibration software	Proprietary Standalone GUI based calibration software matched with probe stations and commercial VNAs Calibration Method must support minimum SOLT, Multi-line TRL cal, eLRRM, Hybrid LRRM-SOLR Cal (multiport), 16-Term SVD, LRRM and LRM+ Compatible with live data measurement Automatic calibration feature to measure S-parameters	

	RF calibration substrates with probe tip pitch range of GSG probes: (3) 50um – 150um (Qty: 02) (4) 100um - 250um (Qty: 02)	Self-developed On-Wafer RF Calibration Substrate or Impedance Standard Substrates for DC- 110 GHz or better Short, Open 50 Ω Load, Through for GSG Probe	
7	**Light shielding**		
	Wafer access	Front access door with rollout stage for easy wafer loading	
	Probe compatibility	Standard Micro Chamber top hat compatible to allow access for up to eight probes	
	Light attenuation	≥ 120 dB or better	
8	**Micro chamber**		
	EMI Shielding	≥ 20 dB 0.5-20 GHz (typical) or better	
	Spectral noise floor*	≤ -150 dBVrms/rtHz (≤ 1 MHz) Non thermal or better	
	System AC Noise	≤ 15 mVp-p (≤ 1 GHz) Non thermal or better	
9	**System electrical performance**		
	Probe leakage	≤ 1 fA or better	
	Chuck leakage	≤ 600 fA or better	
	Capacitance variation **	≤ 75 fF or better	
10	**Microscope and Video Camera**		
	Type	High magnification colour CCD / CMOS digital microscope system	
	Field of view	2.62 x 1.97mm (Max), minimum FOV is approximately 1/10 of the maximum FOV shown or better	
	Optical paths	2	
	Z drive resolution	0.2um or better	
	Zoom range	0.5 – 5.0 or wider	
	Video frame rates (1024 x 768)	45.5fps or better	
11	**Vibration isolation Table**	The prober should have built-in vibration isolation	

		or be equipped with an additional vibration isolation table.	
	Vertical and horizontal natural frequency	Typical performance better than 0dB at 6Hz, with -6 dB per octave roll-off to 48Hz and >-18 dB attenuation above 48Hz (with a semi-automatic 8" probe station or equivalent load) or better	
	Integrated accessory mount	1 Nos Computer accessory mounting kit for keyboard, mouse, joystick.	
	Monitor mount	1 nos Multi-directional LCD monitor support arm	
11	**Mandatory accessories**	Any mandatory accessories, such as suitable vacuum pump for wafer stabilization on the chuck must be supplied together with the system.	
12	**Warranty**	1 year + 2 years additional	
13	**Install base**	Min 50 stations	
14	**Standard system**	No customization allowed	

D. Vector Network Analyzer Technical Specifications – (Qty: 01)

A vector network analyzer is required for on wafer RF characterization of active devices, such as S-Parameters. Linear as well as non-linear measurements of these devices are within the scope of this measurement setup. Proposed Network Analyzer should be dedicated one box solution / integrated system, with two internal signal sources, internal signal combiner, and a flexible set of switches and RF access points for measurements of the passive and active devices. System must have all the required hardware and software installed in it as per the specifications given below:

Sr. No	Parameters	Specifications	Compliance (Yes/No)
1.	Operating frequency range	50 MHz to 67 GHz or wider	
2.	Number of ports	Two	
3.	Number of DDS sources	Two	
4.	Frequency stability	0.1 ppm/year or better	
5.	Frequency accuracy	$\pm 1X10^{-6}$ or better	
6.	Frequency resolution	1Hz or better	

7.	Power resolution	10mdB or better	
8.	IF bandwidth	15MHz or better	
9.	Maximum levelled Power with all options installed, Hi Power mode	50 MHz to 2 GHz: -80 dBm to +15 dBm or better 2GHz to 30 GHz :-80 dBm to +10 dBm or better 30GHz to 40 GHz :-80 dBm to +6 dBm or better 40 GHz to 67 GHz :-80 dBm to +10 dBm or better	
9b	Power Level Linearity	± 1.5dB or better	
9c	Power sweep range	≥ 37 dB : 50MHz to 30GHz or better ≥ 31 dB : 30GHz to 67GHz or better	
9d	Test port Input Noise Floor (dBm) @ 10 Hz IFBW, All Ports	≥105 dB : 50MHz to 67GHz or better	
10.	Direct Access to source and receivers	Should be available on all ports	
11.	Source and Receiver Attenuators	a. Should be available on all ports b. 50 dB source attenuator in 10 dB steps or better c. 50 dB receiver attenuator in 10 dB steps or better	
12.	Directivity	≥ 40 dB : 50MHz to 20GHz or better ≥ 38 dB : 20GHz to 50GHz or better ≥ 32 dB : 50GHz to 67GHz or better	
13.	Source and Load Match	≥ 36 dB 50MHz to 20GHz or better ≥ 31 dB : 20GHz to 50GHz or better ≥ 24 dB : 50GHz to 67GHz or better	
14.	Reflection Tracking	≤ 0.15 dB (over the entire frequency range) or better	
15.	Transmission Tracking	≤ 0.25 dB (over the entire frequency range) or better	
16.	Phase Tracking	±1.5^{o} (over the entire frequency range) or better	
17.	Dynamic Range at test port with all options	≥ 129dB : 500 MHz to 26.5 GHz or better ≥ 110dB :26.5 GHz to 67 GHz or better	

18.	Phase Noise @10 KHz offset	≥ 130Bc at 1GHz CW frequency or better ≥ 110dBc : 10GHz CW frequency or better ≥ 106dBc : 20GHz CW frequency or better	
19.	Source Harmonics	≤ -50 dBc till 2GHz or better ≤ -60 dBc till 35GHz or better	
20.	Internal combiner within VNA	a. Should be available within VNA over the entire frequency range. b. Combined signal output level at test port should be calibrated over the entire frequency range. c. System should have internal switch for making it convenient to change over from/to IMD measurement to/from Normal S-parameter or any other measurement should not require any physical connection/disconnection etc. of DUT with VNA or within VNA. d. Leveled output power at port -1 (meeting harmonics specification) during IMD test should be i) Minimum +5 dBm in 500 MHz to 16GHz frequency band or better Ii) Minimum -1 dBm in 16 to 35 GHz frequency band or better iii) Minimum -5 dBm in 35 GHz to 67 GHz or better e. Variable tone spacing from 100 KHz to 500 MHz should be provided.	
21.	Measurement Parameters	s_{11}, s_{12}, s_{21}, s_{22}, a_1,b_1, r_1,r_2, arbitrary ratio	
22.	Measurement Features	f. S-parameters of amplifiers g. System should have capability to test all	

		above parameters together without any connections/ disconnections with DUT or within VNA. h. Provides ability to independently set the frequency of internal sources and receivers, and to configure external sources i. Swept 2–tone inter-modulation measurements. j. Upgradeable for intermodulation distortion measurements over swept frequency and IMD spectrum at spot frequency.	
23.	Test Port Connector	1.85mm(male) bulk head, 50 ohms (nom.)	
24.	Calibration	d. System should support source power calibration and suitable USB power sensor 67GHz should be provided e. System should support calibration of multiple channels with IMD, S-parameter and Gain compression in a single calibration session. f. Calibration over entire desired frequency range is needed for following parameter measurements: S-Parameters, Gain Compression, IMD of amplifiers.	
25.	Calibration Kit and cables	b. Require electronic calibration kit up to 67GHz: This calibration kit shall have RF connectors (M/F) compatible to DUT end of test port cables. Calibration kit, with which system specifications including measurement accuracies are guaranteed, must be quoted.	

		b. Require compatible flexible VNA test port cables (Qty: 02). Minimum length: 2 feet. Interface for cables: vi. Cable -1 DUT end: 1.85 mm (F) vii. Cable -2 DUT end: 1.85 mm (M) viii. Other ends should be compatible with VNA ports. ix. 1.85 mm (m) to 1.85 mm (m) adapter x. 1.85 mm (f) to 1.85 mm (f) adapter	
26.	Suitable Torque wrench for VNA test ports and 1.85 mm connectors.	1 no. each	
27.	Bias Tee Inputs	Maximum Bias Current ±200 mA or better	
		Connectors BNC(f) for ports 1, 2, 3 and 4	
		Maximum Bias Voltage ±40 VDC or better	
28.	Display	≥ 10 inch color touch screen or better	
29.	Operating System	Windows 7 or later	
30.	Internal Hard Disk	min. 80 GB internal storage capacity (solid state drive) or better	
31.	Capability to save data in ASCII (including S2P)	Feature should be available in the instrument. All files should be compatible to Windows for easy data transportation and documentation.	
32.	Interfaces	GPIB, LAN, USB and VGA output.	
33.	Printer interface	Standard interface, preferably USB, to be provided.	
34.	AC Power Supply	220 to 240 VAC @ 50Hz.	
35.	GPIB card	For PCIe interface along with 4m or longer GPIB cable	
35.	Warranty	3 years.	
36	Bias Network Series ; Qty 2	Frequency range :10 MHz to 67 GHz or wider Connector type: RF input & output 1.85mm (f) ,	

		Maximum current 0.5 Amps or better Maximum voltage 40 Volts or better Max. RF power 1 Watts or better	
37.	Software & Automation Tool	1. Automation tool for simple, fast and scalable test software development. 2. Automation software should be text based automation with the provision to develop custom plugins for instrument control based on SCPI as well as device-under-test control. 3. Software should provide user interfaces as follows: — Graphical user interface — Command line interface. 4. Automation software should have capability to save test results in at least in the following formats: — Text file — Excel —CSV — STDF — HTML — PDF. 5. Automation software should provide facility for data visualization, test optimization and speed analysis: — Test time Analyzer — Test Results Visualizer. 6. Automation software should support additional tools like plugin manager etc. 7. Automation software should have flexibility to configure automated test systems by remote-control from an external program.	
	Option & future upgradeable		
38.	g. The Analyzer should be upgradeable to Pulse measurements with three pulse generators and two pulse modulators using external box/ interconnections.		

	h. The Analyzer should be upgradeable to 4 ports, 2 sources and internal combiner without using external box/ interconnections. i. The Analyzer should be upgradeable to low frequency 900Hz j. The Analyzer should be upgradeable to Gain compression measurement with swept frequency. k. System should support upgradeability for group delay and TDR measurements. l. System to be supported with 1 x license software tool for designing linear circuits/passive circuits and its simulation with FEM and MOM techniques. Tool should be able to generate X parameters for nonlinear circuits with multi tone sources. Should provide mature wireless libraries, provide PHY level systems/models that conform to Wireless Connectivity Standards providing "Golden Reference" models to simulate and verify algorithm and system performance early in the design phase.	
Terms and Conditions: Compliance to the below points shall be supplied along with the quote. Wherever applicable, technical literature shall be supplied.		**Compliance (Yes/No)**
10. A single box solution shall be provided for complete specifications of this document. 11. All the specifications offered by vendor shall be guaranteed specifications referenced to instrument's published technical datasheet. 12. If any specification is specified as typical value only, in vendor datasheet then vendor must certify separately that the delivered instrument will comply with the tender specification at the time of installation/commissioning. 13. In case both guaranteed as well as typical specs are given in datasheet, then only guaranteed specs will be considered. Typical specs will be ignored. 14. Vendor must clearly mention the relevant page number/s of datasheets referring to each specification 15. Vendor should indicate the quoted equipment model and accessories parts numbers in support for each specification in tabular form. Vendor to provide point-by-point compliance, consistent with point no. 3, for the above specifications. 16. All parts/accessories should have operating power: 220 to 240 V AC, 50 Hz. All necessary power cords with Indian (3-pin plug) type to be provided by vendor. 17. Temperature range over which all the specification shall be met : 23 ± 3 deg. C 18. Operating temperature range from 0 deg. to 40 deg. C. 10. Warranty: Minimum 3 years warranty is must. If standard warranty is one year, vendor to quote for additional two years warranty separately.		

C. Precision Source/Measure Unit, 2 ch, 10 fA, 210 V, 3 A DC/10.5 A Pulse

• **Item** Integrated 4-quadrant source and measurement capabilities • The 4.3'' color display supports both graphical and numerical view modes • Free application software to facilitate PC-based instrument control • High throughput and SCPI command supporting conventional SMU command set	**Compliance (Yes/No)**

5. Supports two-channel configuration 6. Minimum source resolution: 10 fA/100 nV, minimum measurement resolution: 10 fA/100 nV or better 7. Maximum output: 210 V, 3 A DC/10.5 A pulse or better 8. Arbitrary waveform generation and digitizing capabilities from 10 μs interval or better	

D. Tender Specifications for 10 MHz – 67 GHz USB Thermocouple Power Sensor- Qty 1 nos

Parameter	**Specification**	**Compliance (Yes/No)**
• Frequency range of 10 MHz to 67 GHz or wider • Fastest measurement speed for thermocouple sensor, > 900 readings/s (free run/fast buffer mode) or better • Best-in-class power linearity of less than 0.8% or better • Wide dynamic range from -35 dBm to +20 dBm or better • Real time measurement uncertainty (MU) feature • S-parameter and gamma correction function		

E. <u>Bid Evaluation / Special Terms for Bidders : (</u>Compliance (Yes/No)

7. Bidders must provide point-by-point compliance to all tendered Technical Specifications, Technical Requirements and Special Terms. Where required, vendor must provide compliance, deviation if any and requisite justification to meet tender requirements in total. Without such details, bids may be summarily rejected at discretion of IIT Delhi.
8. Bids complying with only part requirements of tendered specifications are liable to be rejected. Bidder is accountable for supply, integration, installation and support of all quoted parts including any third party parts not manufactured by them, akin to a turnkey bid. All necessary authorizations must be obtained from third party/part suppliers confirming support to the primary bidder to quote, honor OEM warranty and support during integration, warranty period and for life of the product.
9. Vendors for main test equipment and probe stations must have their own technically equipped application engineer / engineering team to provide installation, training and after sales support.
10. Primary vendor OEM should have well established repair and calibration facility for all supplied main equipment within India.
11. Warranty: Three years on the complete integrated solution.
12. At least 5 similar setup should be found in India.

Vendor Selection /Bid evaluation requirement / criteria (Compliance (Yes/No))

1.	Number of similar units installed in academia / industry worldwide: *>50*
2.	Number of similar units installed within India : *At least 1*

3.	Vendor to attach detailed published technical brochure /data sheet as supporting document. And website link to be provided for the same
4.	**Installation and Commissioning** i) Installation, complete interfacing of the system with its subsystems, and commissioning is to be carried out by the vendor's factory-trained engineers, followed by a demonstration of the system's performance to the user's complete satisfaction. ii) An estimated time schedule for installation, commissioning and training must be provided.
5.	**Training** i) The manufacturer/supplier of RF Measurement System should provide at least seven days onsite training initially during installation ii) The supplier or manufacturer should also provide dedicated five days advanced training subsequent to the above training installation. iii) Regular follow up training every six months during the period of extended warranty on mutually convenient dates for hardware, software and application to the laboratory personnel in the installation, operation and maintenance of the instruments.
6.	**Warranty** System should be covered for comprehensive warranty for 3 years from the manufacturer **All parts including spares should be covered under the warranty and this fact should be clearly and explicitly specified in the tender document.** The comprehensive Warranty should cover: 1. All parts including accessories, spares and labour on site 2. Free maintenance and service on site or at factory with no cost, and 3. Regular up-gradation of software
7.	**Power Supply** : Should meet Indian Power standards preferably without use of external converters
8.	**System Consumable Parts**: Basic frequently required spares should be provided for the entire period of extended warranty. A list of these items should be attached with the quotation. The standard scope of supply should include performance verification standards and comprehensive list of consumables for trouble free operation.
9.	**Support and Service:** 1. The manufacturer and/or their Indian representative must have at least two qualified and factory trained service engineer in India to be able to attend to service at IIT Delhi within 48 hours on submitting a complaint. Training certificates from the manufacturer have to be provided with the tender. 2. For warranty period only factory trained and certified engineers are acceptable to attend the service. 3. The response time with an engineer on site must be less than 48 hours from the notification of the failure. The company must provide evidence that it can fulfil this requirement. 4. In case the parts are required to be imported for repairs, the same should be made available within 2 weeks from the date of reporting of the issue. Any extension in this time will need to be compensated by the manufacturer by extending the comprehensive warranty by the excess period taken (i.e. period beyond 2 weeks) in completing the repairs. 5. A 10% performance guarantee will need to be maintained during the period of extended warranty.

I have also enclosed all relevant documents in support of my claims, (as above) in the following pages.

Signature of Bidder

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

ANNEXURE-II

<< Organization Letter Head >>

DECLARATION SHEET

We, _____ hereby certify that all the information and data furnished by our organization with regard to this tender specification are true and complete to the best of our knowledge. I have gone through the specification, conditions and stipulations in details and agree to comply with the requirements and intent of specification.

This is certified that our organization has been authorized (Copy attached) by the OEM to participate in Tender. We further certified that our organization meets all the conditions of eligibility criteria laid down in this tender document. Moreover, OEM has agreed to support on regular basis with technology / product updates and extend support for the warranty.

The prices quoted in the financial bids are subsidized due to academic discount given to IIT Delhi.

We, further specifically certify that our organization has not been Black Listed/De Listed or put to any Holiday by any Institutional Agency/ Govt. Department/ Public Sector Undertaking in the last three years.	NAME & ADDRESS OF THE Vendor/ Manufacturer / Agent
1 Phone	
2 Fax	
3 E-mail	
4 Contact Person Name	
5 Mobile Number	
6 GST Number	
7 PAN Number	
(In case of on-line payment of Tender Fees) 8 UTR No. (For Tender Fee)	
(In case of on-line payment of EMD) 9 UTR No. (For EMD)	
10 Kindly provide bank details of the bidder in the following format: a) Name of the Bank	
b) Account Number	
c) Kindly attach scanned copy of one Cheque book page to enable us to return the EMD to unsuccessful bidder	

(Signature of the Tenderer)

Name:

Seal of the Company

Annexure-III

List of Govt. Organization/Deptt.

List of Government Organizations for whom the Bidder has undertaken such work during last three years (must be supported with work orders)		
Name of the organization	**Name of Contact Person**	**Contact No.**

Name of application specialist / Service Engineer who have the technical competency to handle and support the quoted product during the warranty period.		
Name of the organization	**Name of Contact Person**	**Contact No.**

Signature of Bidder

Name: _____

Designation: _____

Organization Name: _____

Contact No. : _____

PREVIOUS SUPPLY ORDER DETAILS

Annexure - IV

Name of the Firm_____

Order placed by (Full address of Purchaser)	Order No. and Date	Description and quantity of order equipment	Value of order	Date of Completion of delivery as per contract	Has the equipment been installed satisfactorily (Attach a Certificate from the Purchaser/ Consignee)	Contact person along with Telephone No., Fax No. and email address)

Signature and Seal of the Manufacturer/ Bidder

_____

Place: _____

Date: _____

ORIGINAL EQUIPMENT MANUFACTURER (OEM)
Manufacturing authorisation form (MAF)
(On Letter Head of Manufacturer)

ANNEXURE-V (Revised)

Tender No. :- …… Date:- ……..

To
The Director,
Indian Institute of Technology Delhi,
New Delhi- 110016

Dear Sir,

We manufactures of original equipment at (……..address of factory……) do hereby authorize M/s *(Name and address of Agent)* to submit a bid, negotiate and receive the order format against your tender enquiry.

M/s. …….. is authorized to bid and conclude the contract in regard to this business.

We hereby extend our full guarantee and warranty as per clause …… of the terms and conditions NIQ for the goods and services offered by the above firm.

Yours Faithfully,

(Name)

(Name & Seal of Manufactures)

Note: -

1. **Items of indigenous nature or quoted in INR**, more than 1 authorized representative may participate in the same tender and submit their bids on behalf of their OEM/Principal/Manufacturer if the OEM permits more than one authorized bidder in such case as per their policy.

2. **In cases of agents quoting in offshore procurements,** on behalf of their principal manufacturers, one agent cannot represent two manufacturers or quote on their behalf in a particular tender enquiry. **One manufacturer can also authorize only one agent/dealer**

3. The letter of authority should be on the letterhead of the manufacturer and should be signed by a person competent and having the power of attorney to bind the manufacturer. The same should be included by the bidder in its techno-commercial unpriced bid.

Bid Submission

Online Bid Submission:

The Online bids (complete in all respect) must be uploaded online in **two** Envelops as explained below:-

Envelope – 1 (Following documents to be provided as single PDF file)			
Sl. No.	**Document**	**Content**	**File Types**
1.	Technical Bid	Compliance Sheet as per Annexure - I	.PDF
2.		Organization Declaration Sheet as per Annexure - II	.PDF
3.		List of organizations/ clients where the same products have been supplied (in last two years) along with their contact number(s). (Annexure-III)	.PDF
4.		Technical supporting documents in support of all claims made at Annexure-I (Annexure-IV)	.PDF
5.		PREVIOUS SUPPLY ORDER as per Annexure - IV	.PDF
6.		ORIGINAL EQUIPMENT MANUFACTURING (OEM) MANUFACTURING AUTHORISATION FORM as per Annexure - V	.PDF
Envelope – 2			
Sl. No.	**Document**	**Content**	
1.	Financial Bid	Price bid should be submitted in given BOQ_XXXX.xls format. (***Note: -Comparison of prices will be done ONLY on the bids submitted for the Main Equipment and anything asked as 'Optional' in the specs is not to be included for overall comparison.)*** Bids for optional items are to be submitted in 'sheet2_Quote for optional items'	.XLS